



NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE55P30 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

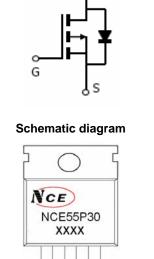
General Features

- V_{DS} =-55V,I_D =-30A
 R_{DS(ON)} <40mΩ @ V_{GS}=-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!



Marking and pin assignment



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| NCE55P30 | NCE55P30 | TO-220-3L | - | - | - |

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit | |
|--|-----------------------|------------|------|--|
| Drain-Source Voltage | Vds | -55 | V | |
| Gate-Source Voltage | Vgs | ±20 | V | |
| Drain Current-Continuous | Ι _D | -30 | А | |
| Drain Current-Continuous(T _C =100℃) | I _D (100℃) | -21 | А | |
| Pulsed Drain Current | I _{DM} | 110 | А | |
| Maximum Power Dissipation | PD | 90 | W | |
| Derating factor | | 0.72 | W/℃ | |
| Single pulse avalanche energy (Note 5) | E _{AS} | 420 | mJ | |
| Operating Junction and Storage Temperature Range | TJ,TSTG | -55 To 150 | °C | |





Thermal Characteristic

| Thermal Resistance, Junction-to-Case ^(Note 2) | R _{θJC} | 1.39 | °C/W |
|--|------------------|------|------|
|--|------------------|------|------|

Electrical Characteristics (T_c=25[°]C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|--|--------------|------------|-----------|----------|
| Off Characteristics | · | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =-250µA | -55 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-55V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | · | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} ,I _D =-250µA | -2 | -2.6 | -4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =-10V, I _D =-15A | - | 30 | 40 | mΩ |
| Forward Transconductance | g fs | V _{DS} =-25V,I _D =-16A | 8 | - | - | S |
| Dynamic Characteristics (Note4) | | | | | | |
| Input Capacitance | C _{lss} | <u>)/ 20)//)/ 0)/</u> | - | 3500 | - | PF |
| Output Capacitance | C _{oss} | V _{DS} =-30V,V _{GS} =0V, F=1.0MHz | - | 240 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0WHZ | - | 153 | - | PF |
| Switching Characteristics (Note 4) | · | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 12 | - | nS |
| Turn-on Rise Time | tr | V _{DD} =-30V,I _D =-15A | - | 15 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =-10V, R_{GEN} =3 Ω | - | 38 | - | nS |
| Turn-Off Fall Time | t _f | | - | 15 | - | nS |
| Total Gate Charge | Qg | 1/ - 44/1 - 160 | - | 56 | - | nC |
| Gate-Source Charge | Q _{gs} | V _{DS} =-44V,I _D =-16A, V _{GS} =-10V | - | 11 | - | nC |
| Gate-Drain Charge | Q _{gd} | v _{GS} =-10v | - | 24 | - | nC |
| Drain-Source Diode Characteristics | · | | • | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =-24A | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | I _S | | - | - | -30 | А |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, IF = -15A | - | - | 71 | nS |
| Reverse Recovery Charge | Qrr | di/dt = 100A/µs ^(Note3) | - | - | 170 | nC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negl | igible (turi | n-on is do | minated b | y LS+LD) |

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- $\textbf{5.} \ \textbf{E}_{AS} \ \textbf{condition:} \ \ \textbf{Tj=25}^{\circ} \textbf{C}, \textbf{V}_{DD} \textbf{=-25V}, \textbf{V}_{G} \textbf{=-20V}, \textbf{L=1mH}, \textbf{Rg=25\Omega}, \textbf{I}_{AS} \textbf{=-29A}$

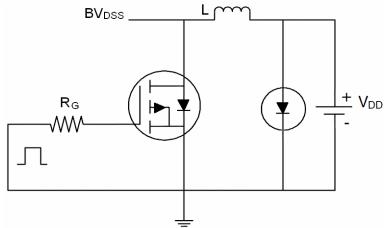


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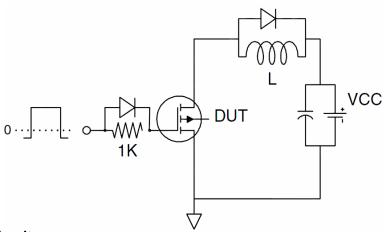




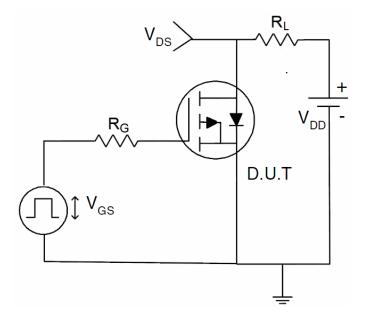
Test Circuit 1) E_{AS} Test Circuit



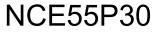
2) Gate Charge Test Circuit



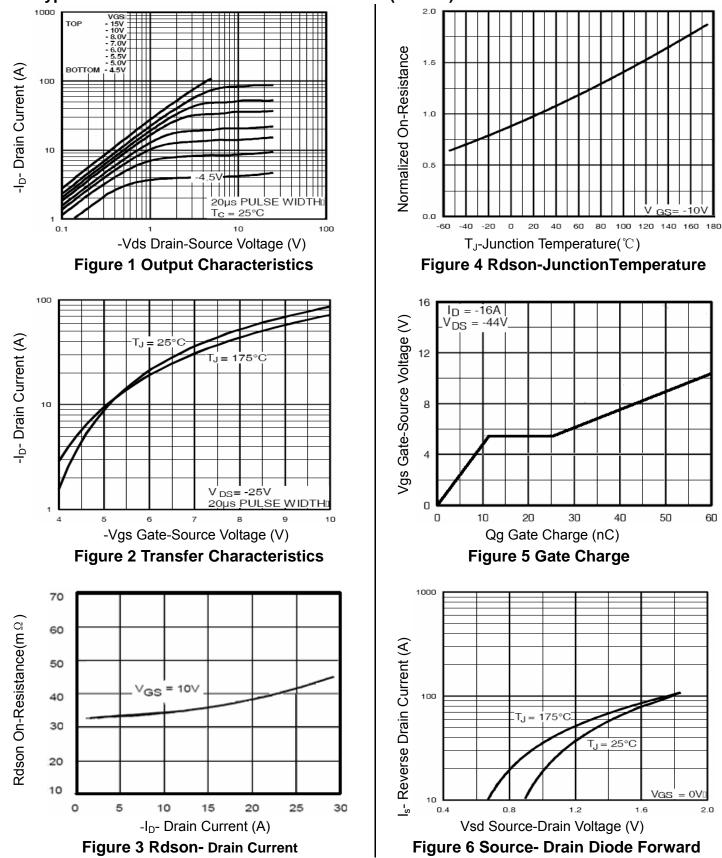
3) Switch Time Test Circuit







Typical Electrical and Thermal Characteristics (Curves)





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NCE55P30

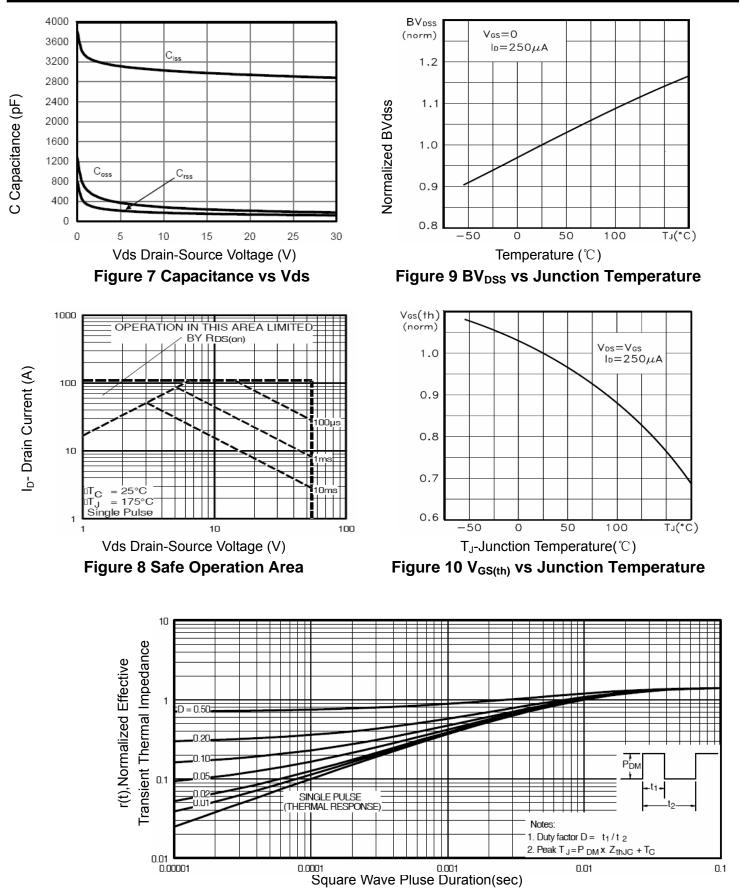


Figure 11 Normalized Maximum Transient Thermal Impedance

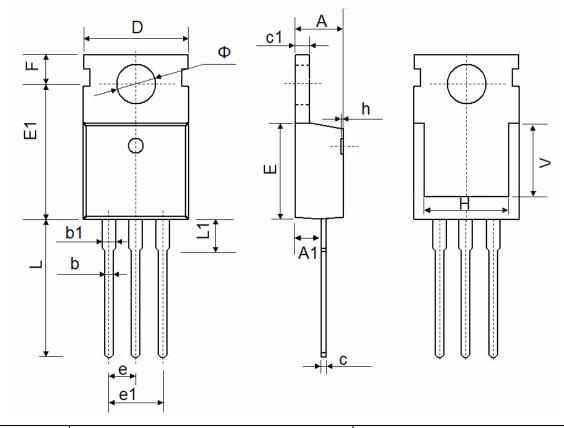


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TO-220-3L Package Information

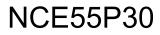


| Symbol | Dimensions | n Millimeters | Dimensions In Inches | | |
|--------|------------|---------------|----------------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| А | 4.400 | 4.600 | 0.173 | 0.181 | |
| A1 | 2.250 | 2.550 | 0.089 | 0.100 | |
| b | 0.710 | 0.910 | 0.028 | 0.036 | |
| b1 | 1.170 | 1.370 | 0.046 | 0.054 | |
| С | 0.330 | 0.650 | 0.013 | 0.026 | |
| c1 | 1.200 | 1.400 | 0.047 | 0.055 | |
| D | 9.910 | 10.250 | 0.390 | 0.404 | |
| E | 8.9500 | 9.750 | 0.352 | 0.384 | |
| E1 | 12.650 | 12.950 | 0.498 | 0.510 | |
| е | 2.540 TYP. | | 0.100 TYP. | | |
| e1 | 4.980 | 5.180 | 0.196 | 0.204 | |
| F | 2.650 | 2.950 | 0.104 | 0.116 | |
| Н | 7.900 | 8.100 | 0.311 | 0.319 | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| L | 12.900 | 13.400 | 0.508 | 0.528 | |
| L1 | 2.850 | 3.250 | 0.112 | 0.128 | |
| V | 7.500 REF. | | 0.295 REF. | | |
| Φ | 3.400 | 3.800 | 0.134 | 0.150 | |



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